

on request

High Voltage Thyristor Module

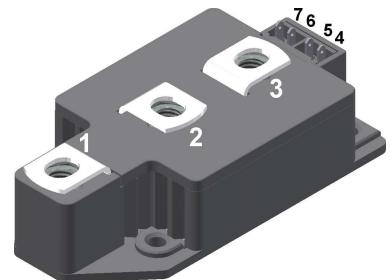
V_{RRM} = 2x2200 V

I_{TAV} = 320 A

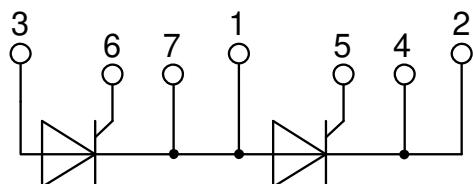
V_T = 1.09 V

Phase leg

Part number

MCC310-22io1


Backside: isolated

 E72873


Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al2O3-ceramic

Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

Package: Y2

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Disclaimer Notice

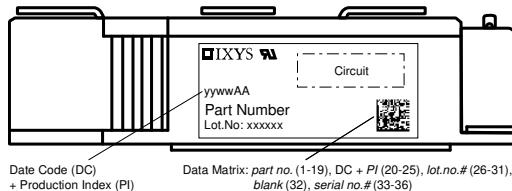
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Thyristor

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$V_{RSM/DSM}$	max. non-repetitive reverse/forward blocking voltage	$T_{VJ} = 25^\circ C$			2300	V
$V_{RRM/DRM}$	max. repetitive reverse/forward blocking voltage	$T_{VJ} = 25^\circ C$			2200	V
$I_{R/D}$	reverse current, drain current	$V_{R/D} = 2200 \text{ V}$ $V_{R/D} = 2200 \text{ V}$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 140^\circ C$		1 40	mA
V_T	forward voltage drop	$I_T = 300 \text{ A}$	$T_{VJ} = 25^\circ C$		1.13	V
		$I_T = 600 \text{ A}$			1.40	V
		$I_T = 300 \text{ A}$ $I_T = 600 \text{ A}$	$T_{VJ} = 125^\circ C$		1.09 1.44	V
I_{TAV}	average forward current	$T_C = 85^\circ C$	$T_{VJ} = 140^\circ C$		320	A
$I_{T(RMS)}$	RMS forward current	180° sine			500	A
V_{TO}	threshold voltage	$\left. \begin{array}{l} \text{slope resistance} \\ \end{array} \right\} \text{for power loss calculation only}$	$T_{VJ} = 140^\circ C$		0.74	V
r_T	slope resistance				1.16	mΩ
R_{thJC}	thermal resistance junction to case				0.11	K/W
R_{thCH}	thermal resistance case to heatsink			0.04		K/W
P_{tot}	total power dissipation		$T_C = 25^\circ C$		1030	W
I_{TSM}	max. forward surge current	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$	$T_{VJ} = 45^\circ C$		8.00	kA
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$V_R = 0 \text{ V}$		8.64	kA
		$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$	$T_{VJ} = 140^\circ C$		6.80	kA
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$V_R = 0 \text{ V}$		7.35	kA
I^2t	value for fusing	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$	$T_{VJ} = 45^\circ C$		320.0	kA²s
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$V_R = 0 \text{ V}$		310.5	kA²s
		$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$	$T_{VJ} = 140^\circ C$		231.2	kA²s
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$V_R = 0 \text{ V}$		224.4	kA²s
C_J	junction capacitance	$V_R = 700 \text{ V}$ $f = 1 \text{ MHz}$	$T_{VJ} = 25^\circ C$	235		pF
P_{GM}	max. gate power dissipation	$t_p = 30 \mu s$	$T_C = 140^\circ C$		120	W
		$t_p = 500 \mu s$			60	W
					20	W
P_{GAV}	average gate power dissipation					
$(di/dt)_{cr}$	critical rate of rise of current	$T_{VJ} = 140^\circ C; f = 50 \text{ Hz}$	repetitive, $I_T = 960 \text{ A}$		100	A/μs
		$t_p = 200 \mu s; di_G/dt = 1 \text{ A/μs}$				
		$I_G = 1 \text{ A}; V = \frac{2}{3} V_{DRM}$	non-repet., $I_T = 320 \text{ A}$		500	A/μs
$(dv/dt)_{cr}$	critical rate of rise of voltage	$V = \frac{2}{3} V_{DRM}$	$T_{VJ} = 140^\circ C$		1000	V/μs
		$R_{GK} = \infty$; method 1 (linear voltage rise)				
V_{GT}	gate trigger voltage	$V_D = 6 \text{ V}$	$T_{VJ} = 25^\circ C$		2	V
			$T_{VJ} = -40^\circ C$		3	V
I_{GT}	gate trigger current	$V_D = 6 \text{ V}$	$T_{VJ} = 25^\circ C$		150	mA
			$T_{VJ} = -40^\circ C$		200	mA
V_{GD}	gate non-trigger voltage	$V_D = \frac{2}{3} V_{DRM}$	$T_{VJ} = 140^\circ C$		0.25	V
I_{GD}	gate non-trigger current				10	mA
I_L	latching current	$t_p = 30 \mu s$	$T_{VJ} = 25^\circ C$		200	mA
		$I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A/μs}$				
I_H	holding current	$V_D = 6 \text{ V}$ $R_{GK} = \infty$	$T_{VJ} = 25^\circ C$		150	mA
t_{gd}	gate controlled delay time	$V_D = \frac{1}{2} V_{DRM}$	$T_{VJ} = 25^\circ C$		2	μs
		$I_G = 1 \text{ A}; di_G/dt = 1 \text{ A/μs}$				
t_q	turn-off time	$V_R = 100 \text{ V}; I_T = 320 \text{ A}; V = \frac{2}{3} V_{DRM}$	$T_{VJ} = 125^\circ C$	350		μs
		$di/dt = 10 \text{ A/μs}$ $dv/dt = 50 \text{ V/μs}$ $t_p = 200 \mu s$				

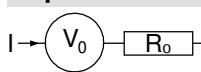
Package Y2

Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			600	A
T_{VJ}	virtual junction temperature		-40		140	°C
T_{op}	operation temperature		-40		125	°C
T_{stg}	storage temperature		-40		125	°C
Weight				255		g
M_D	mounting torque		2.5		5	Nm
M_T	terminal torque		12		15	Nm
$d_{Spp/App}$	creepage distance on surface / striking distance through air	terminal to terminal	13.0			mm
$d_{Spb/Apb}$		terminal to backside	13.0			mm
V_{ISOL}	isolation voltage	$t = 1$ second $t = 1$ minute	3600 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3000		V V



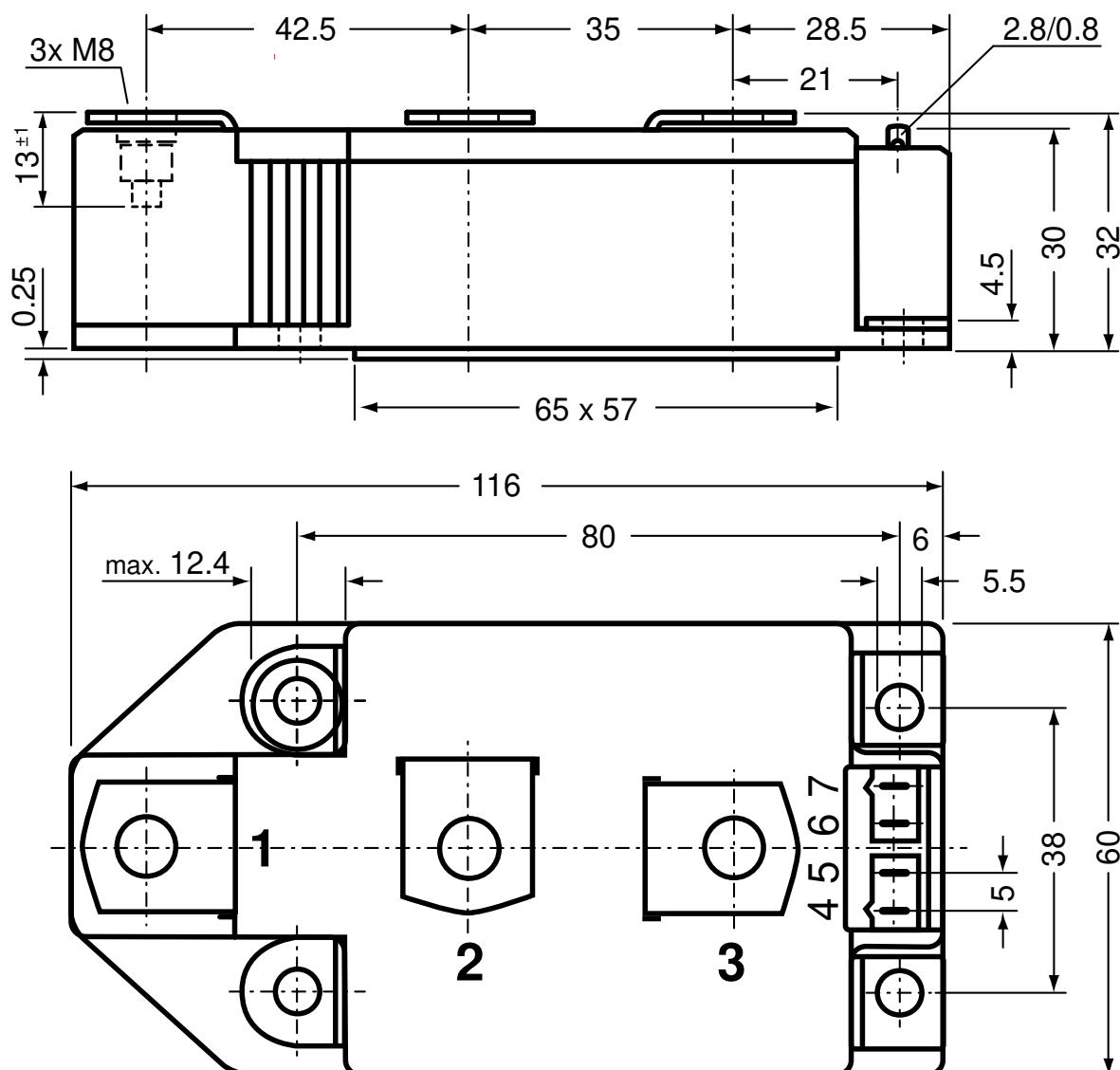
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCC310-22io1	MCC310-22io1	Box	2	on req

Equivalent Circuits for Simulation
^{*}on die level

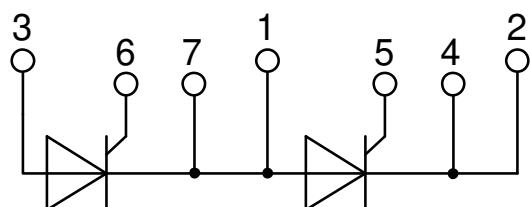
 $T_{VJ} = 140^\circ\text{C}$

Thyristor

$V_{0\max}$ threshold voltage 0.74 V

$R_{0\max}$ slope resistance * 0.97 mΩ

Outlines Y2

Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red

 Type ZY 180L (L = Left for pin pair 4/5) } UL 758, style 3751
 Type ZY 180R (R = Right for pin pair 6/7)


Thyristor

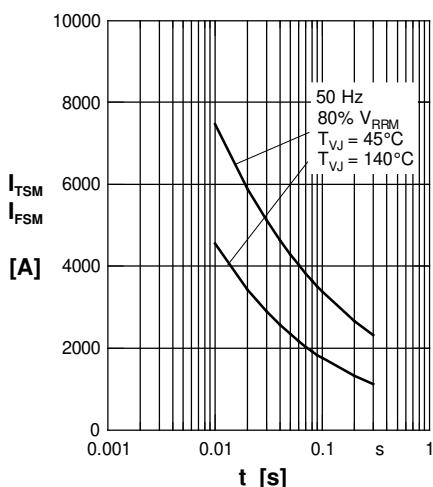


Fig. 1 Surge overload current
 $I_{(F)SM}$: crest value, t : duration

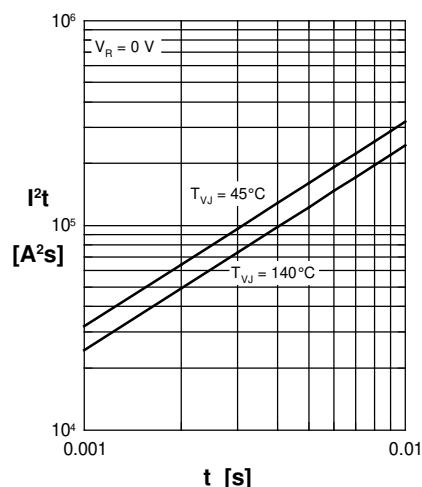


Fig. 2 I^2t versus time (1-10 ms)

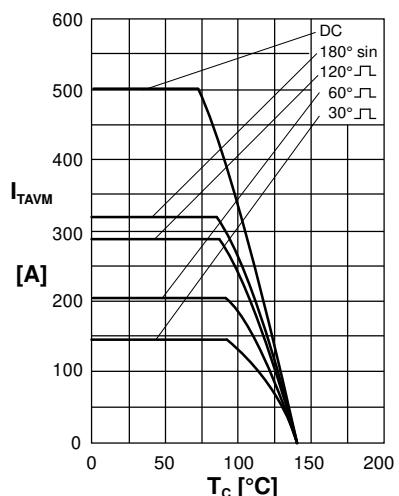


Fig. 3 Max. forward current
at case temperature

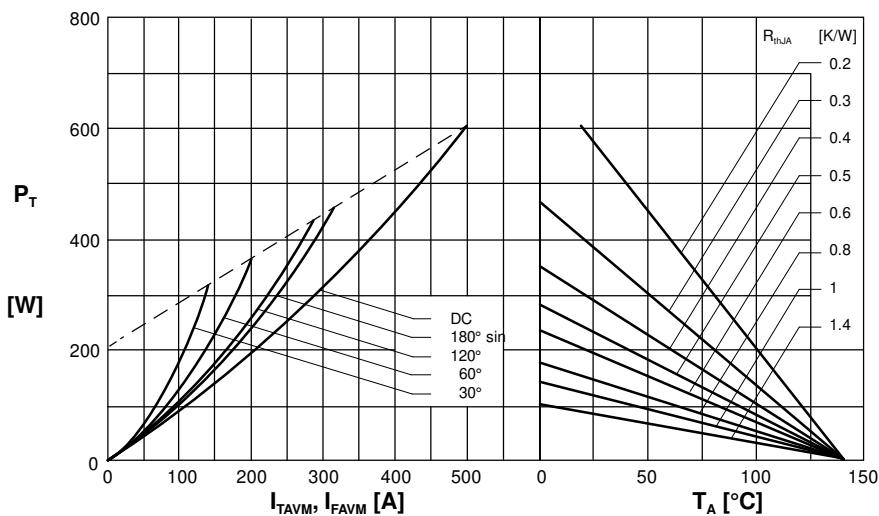


Fig. 4 Power dissipation versus onstate current and•
ambient temperature (per thyristor/diode)

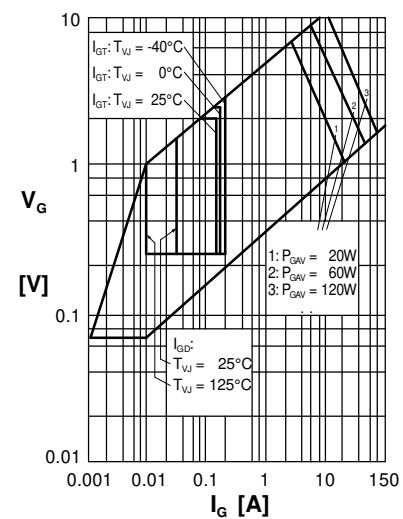


Fig. 5 Gate trigger characteristics

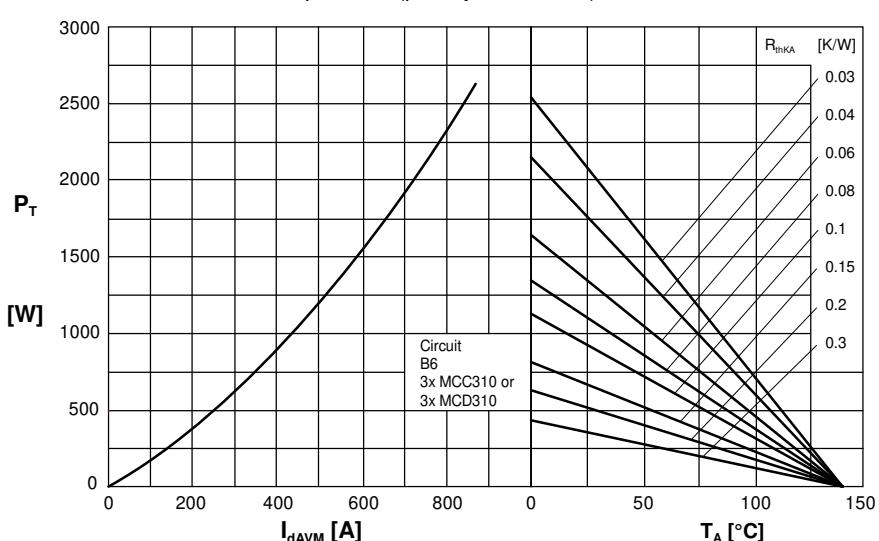


Fig. 6 Three phase rectifier bridge: Power dissipation versus
direct output current and ambient temperature

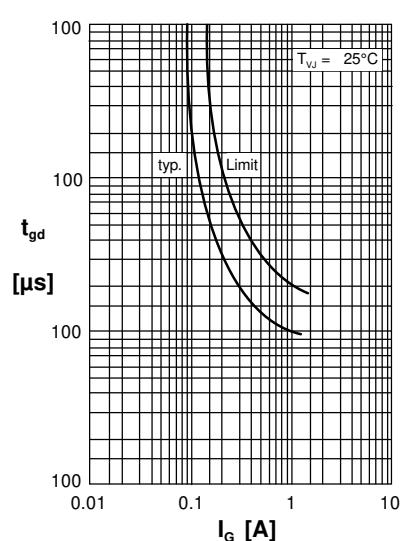


Fig. 7 Gate trigger delay time

Thyristor

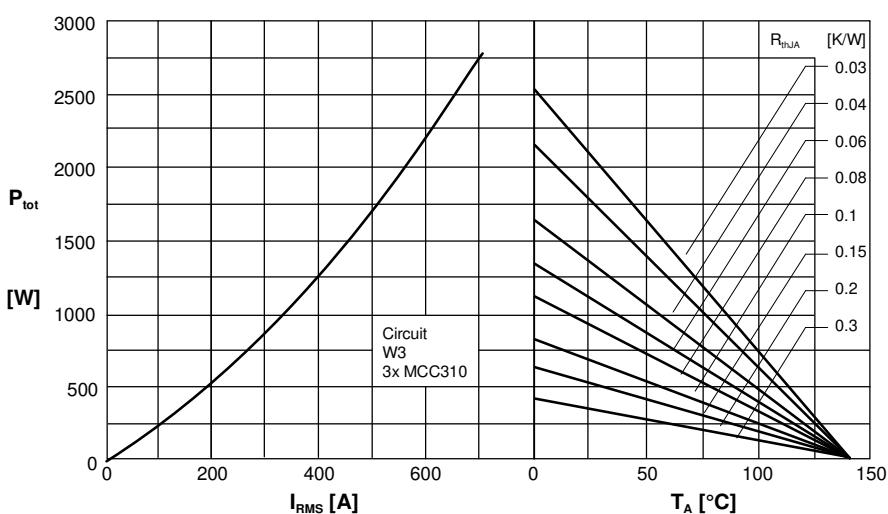


Fig. 7 Three phase AC-controller:
Power dissipation versus RMS output current and ambient temperature

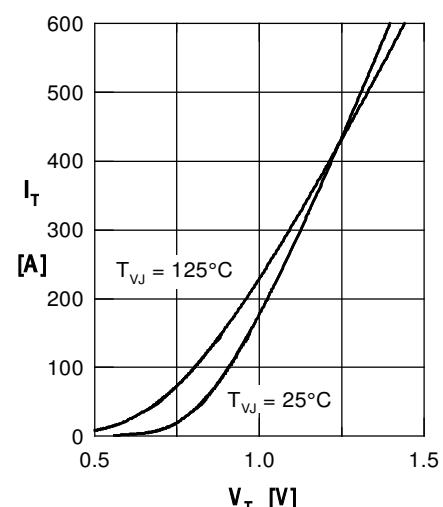


Fig. 10 Forward characteristics

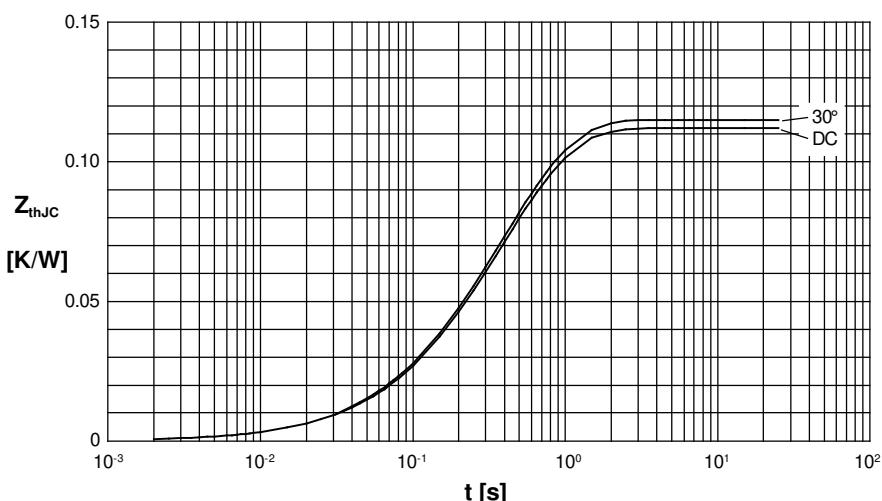


Fig. 8 Transient thermal impedance junction to case (per thyristor)

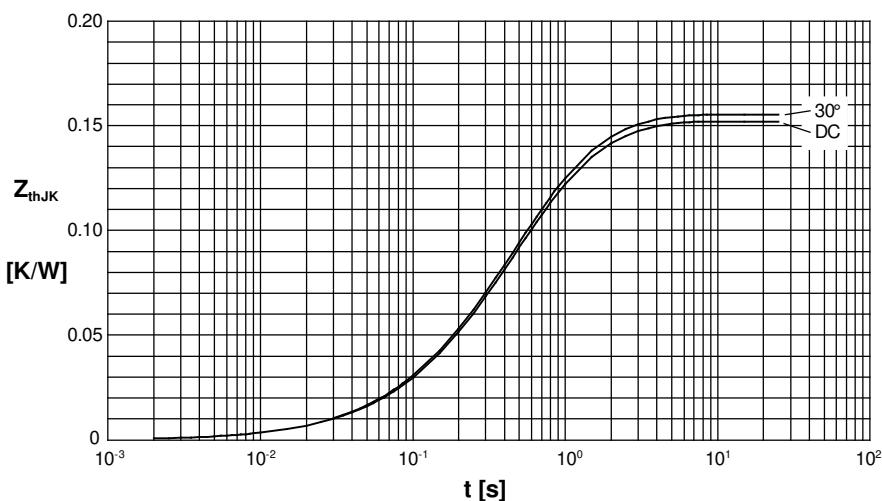


Fig. 9 Transient thermal impedance junction to heatsink (per thyristor)

R_{thJC} for various conduction angles d:

d	R_{thJC} [K/W]
DC	0.112
180°C	0.113
120°C	0.114
60°C	0.115
30°C	0.115

Constants for Z_{thJC} calculation:

i	R_{thi} [K/W]	t [s]
1	0.003	0.099
2	0.0143	0.168
3	0.0947	0.456

R_{thJK} for various conduction angles d:

d	R_{thJK} [K/W]
DC	0.152
180°C	0.154
120°C	0.154
60°C	0.155
30°C	0.155

Constants for Z_{thJK} calculation:

i	R_{thi} [K/W]	t _i (s)
1	0.003	0.099
2	0.0143	0.168
3	0.0947	0.456
4	0.04	1.36